To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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2SC2613

Silicon NPN Triple Diffused

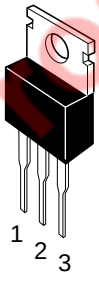
ADE-208-886 (Z)
1st. Edition
September 2000

Application

High voltage, high speed and high power switching

Outline

TO-220AB



1. Base
2. Collector (Flange)
3. Emitter

Absolute Maximum Ratings (Ta = 25°C)

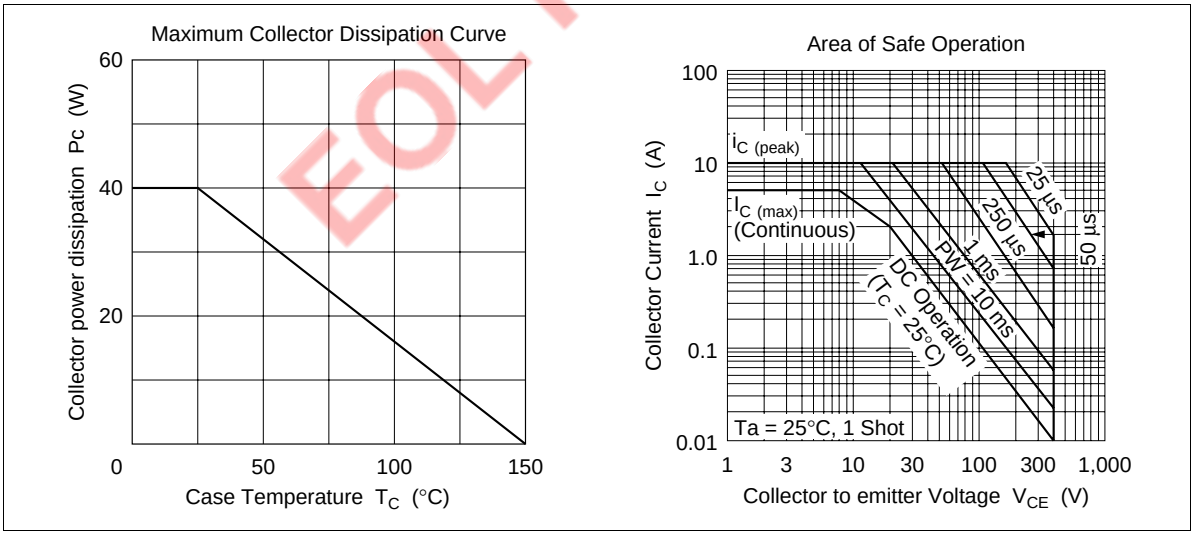
Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	500	V
Collector to emitter voltage	V_{CEO}	400	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I_C	5	A
Collector peak current	$I_{C(peak)}$	10	A
Base current	I_B	2.5	A
Collector power dissipation	P_C*[1]	40	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

Note: 1. Value at T_C = 25°C.

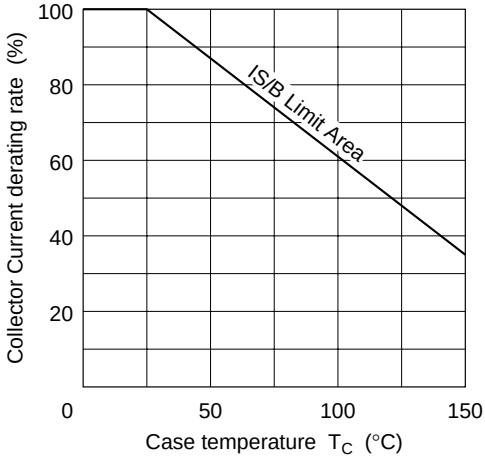
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{CEO(sus)}$	400	—	—	V	I_C = 0.2 A, R_{BE} = ∞, L = 100 mH
	$V_{CEX(sus)}$	400	—	—	V	I_C = 5 A, I_{B1} = –I_{B2} = 1 A, V_{BE} = –5 V, L = 180 µH, Clamped
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	I_E = 10 mA, I_C = 0
Collector cutoff current	I_{CBO}	—	—	100	µA	V_{CB} = 400 V, I_E = 0
	I_{CEO}	—	—	100	µA	V_{CE} = 350 V, R_{BE} = ∞
DC current transfer ratio	h_{FE1}	15	—	—		V_{CE} = 5 V, I_C = 2.5 A*[1]
	h_{FE2}	7	—	—		V_{CE} = 5 V, I_C = 5 A*[1]
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.0	V	I_C = 2.5 A, I_B = 0.5 A*[1]
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	1.5	V	I_C = 2.5 A, I_B = 0.5 A*[1]
Turn on time	t_{on}	—	—	1.0	µs	I_C = 5 A, I_{B1} = –I_{B2} = 1 A,
Storage time	t_{stg}	—	1.2	2.5	µs	V_{CC} ≅ 150 V
Fall time	t_f	—	—	1.0	µs	

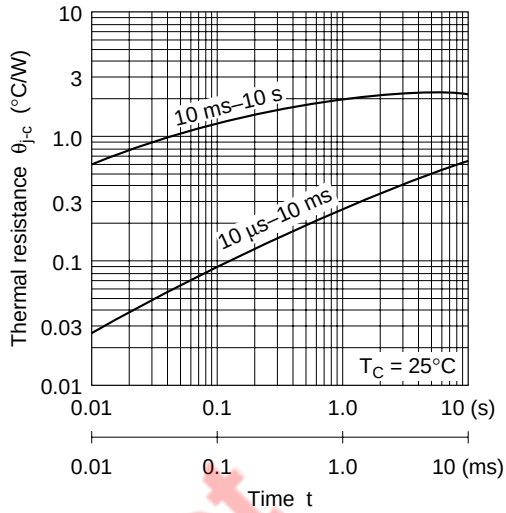
Note: 1. Pulse test.



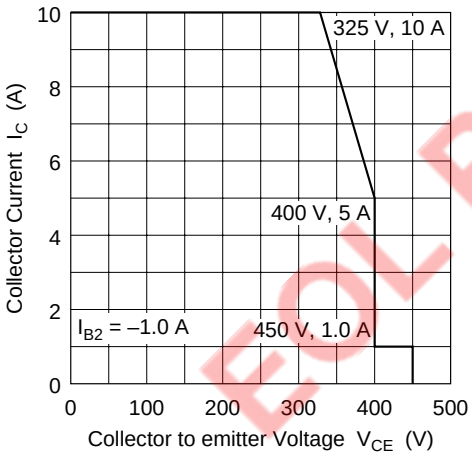
Collector Current Derating Rate



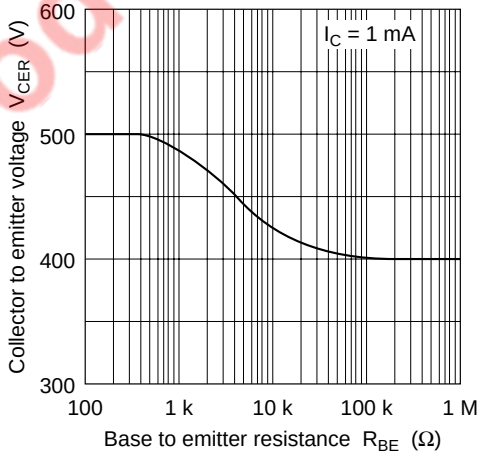
Transient Thermal Resistance



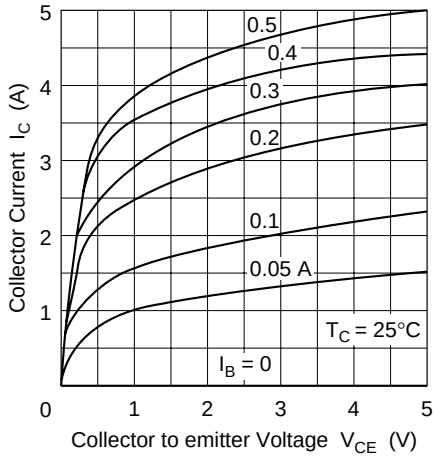
Reverse Bias Area of Safe Operation



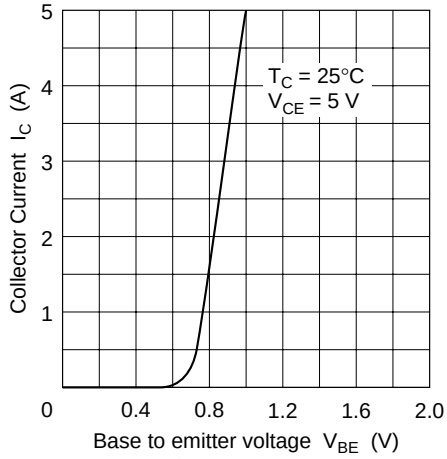
Collector to Emitter Voltage vs. Base to Emitter Resistance



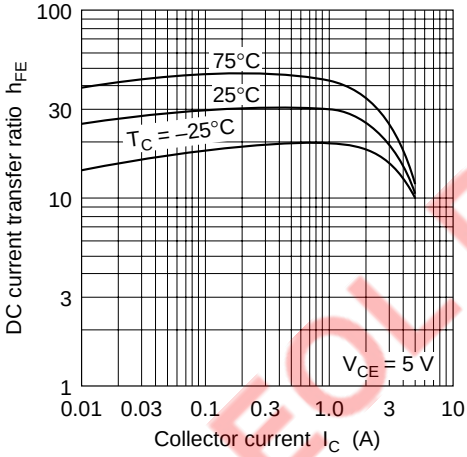
Typical Output Characteristics



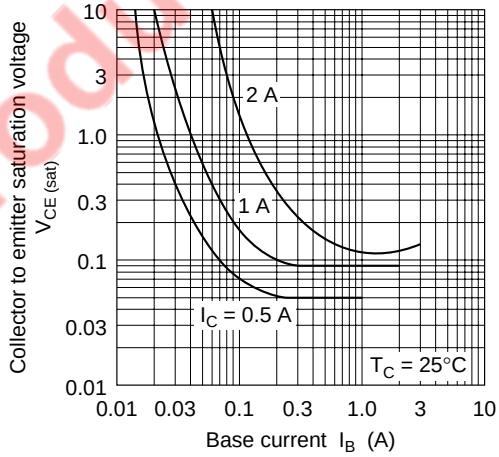
Typical Transfer Characteristics



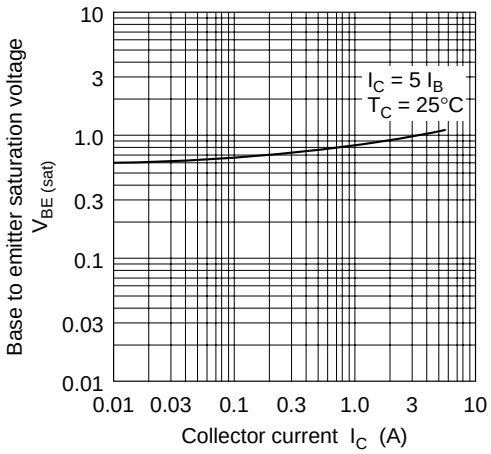
DC Current Transfer Ratio vs. Collector Current



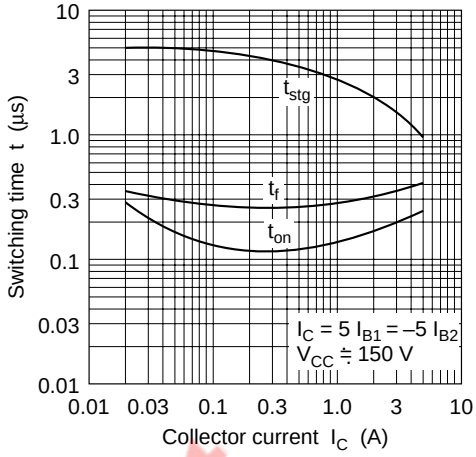
Collector to Emitter Saturation Voltage vs. Base Current



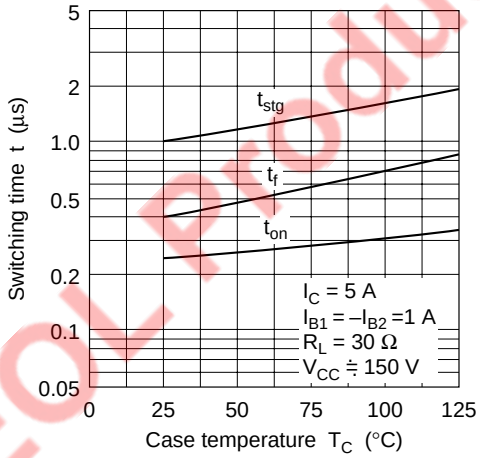
Base to Emitter Saturation Voltage vs. Collector Current



Switching Time vs. Collector Current



Switching Time vs. Case Temperature



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